

Amendments To The Abstract:

In the English translation document, please add the section heading at page 16 line 1, as follows:

--ABSTRACT

The invention relates to a method for repairing components comprising a base material with an oriented microstructure, wherein the repair point comprises a correspondingly oriented microstructure as the surrounding base material. According to the inventive method, solder is applied in the region of a point which is to be repaired and is soldered to the component by means of a heating effect produced by a device. A temperature gradient, i.e., approximately a temperature characteristic, is produced during the heating effect, said temperature characteristic ranging from a high to a low temperature in the region of the point which is to be repaired.--

A clean copy of the Abstract is provided herewith on a separate sheet.